EAST Search History

EAST Search History (Prior Art)

Ref#	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	12205	(epi or epitax\$3) with layer with (trench or hole or via or open)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 12:11
S2	552	S1 with (diode or sensor or PD)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 12:12
SS	40	S2 with (conduct\$3 or contact or connect\$3) with (liner or barrier or fill)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 12:14
S4	53	S2 same (conduct\$3 or contact or connect\$3) with (liner or barrier or fill)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 12:19
S5	1178	S1 same (diode or sensor or PD)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 12:21
S6	131	S5 same (conduct\$3 or contact or connect\$3) same (liner or barrier or fill)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 12:21
S7	81	S6 and (@pd<"20031212" or @ad<"20031212" or @rlad<"20031212")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 12:23

S8	16746	(epi or epitax\$3) with (trench or hole or via or open)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 12:48
S9	360	S8 with (conduct\$3 or contact or connect\$3) with (liner or barrier or fill)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 12:49
S10	209	S9 and (@pd<"20031212" or @ad<"20031212" or @rlad<"20031212")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 12:49
S11	4	("6960483" "7217590").pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/04 09:40
S12	111	("4477835" "5144747" "5244817" "5250843" "5274250" "5586574" "6091194" "6252220" "6257491" "6646289"). PN. OR ("6960483" "7217590"). UJRPN.	US-PGPUB; USPAT; USOCR	OR	ON	2009/08/04 09:40
S13	7	pourquier-eric.in.	US-PGPUB; USPAT; USOCR	OR	ON	2009/08/04 09:41
S14	43838	(substrate or wafer) with (backside or back) with (contact or metal or conductor or connect\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/11 05:16
S15	8788	(substrate or wafer) with (backside or back) with (contact or metal or conductor or connect\$3) with (trench or hole or via or open)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/11 05:17
S16	863	(substrate or wafer) with (backside or back) with (contact or metal or conductor or connect\$3) with (trench or hole or via or open) with (polish\$3 or thin \$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/11 05:17

S17	358	S16 and @pd< "20031212"	US-PGPUB;	OR	ON	2009/08/11
		-	USPAT;			05:18
			USOCR; FPRS;	•		
			EPO; JPO;			
			DERWENT;			
		-	IBM_TDB			
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